TOSHIBA Field Effect Transistor Silicon P Channel MOS Type(π-MOSVI)

SSM3J16CT

High Speed Switching Applications Analog Switch Applications

• Small package

• Low on-resistance : $RDS(ON) = 8 \Omega \text{ (max) } (@VGS = -4 \text{ V})$

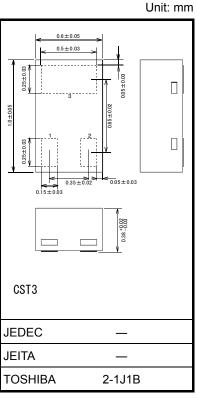
: RDS(ON) = 12 Ω (max) (@VGS = -2.5 V)

: RDS(ON) = $45 \Omega \text{ (max) } (@VGS = -1.5 \text{ V})$

Absolute Maximum Ratings (Ta = 25°C)

| Characteristics | | Symbol | Rating | Unit | |
|---------------------------|-------|------------------------|---------|------|--|
| Drain-Source voltage | | V _{DSS} | -20 | V | |
| Gate-Source voltage | | V_{GSS} | ±10 | V | |
| Drain current | DC | I _D | -100 | mA | |
| | Pulse | I _{DP} | -200 | | |
| Power dissipation | | P _D (Note1) | 100 | mW | |
| Channel temperature | | T _{ch} | 150 | °C | |
| Storage temperature range | | T _{stg} | -55~150 | °C | |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.



Weight: 0.75 mg (typ.)

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

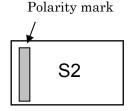
Note 1: Mounted on an FR4 board

 $(10 \text{ mm} \times 10 \text{ mm} \times 1.0 \text{ mm}, \text{Cu Pad: } 100 \text{ mm}^2)$

Marking (Top View)

Pin Condition (Top View)

Polarity mark (on the top)

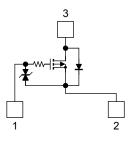


1. Gate

2. Source 3. Drain

*Electrodes: On the bottom

Equivalent Circuit



Handling Precaution

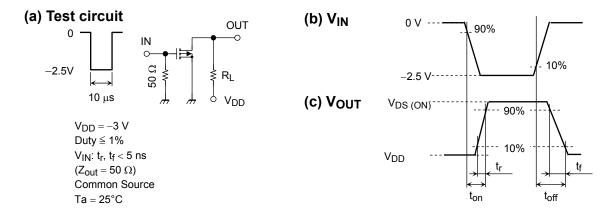
When handling individual devices (which are not yet mounted on a circuit board), ensure that the environment is protected against static electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

Electrical Characteristics (Ta = 25°C)

| Characteristic | | Symbol | Test Condition | MIN. | TYP. | MAX. | UNIT | |
|--------------------------------|---------------|----------------------|---|------|------|------|------|--|
| Gate leakage current | | I _{GSS} | $V_{GS} = \pm 10 \text{ V}, V_{DS} = 0$ | _ | _ | ±1 | μА | |
| Drain-Source breakdown voltage | | V (BR) DSS | $I_D = -0.1 \text{ mA}, V_{GS} = 0$ | -20 | _ | _ | V | |
| Drain cut-off current | | I _{DSS} | $V_{DS} = -20 \text{ V}, V_{GS} = 0$ | _ | _ | -1 | μА | |
| Gate threshold voltage | | V_{th} | $V_{DS} = -3 \text{ V}, I_D = -0.1 \text{ mA}$ | -0.6 | _ | -1.1 | V | |
| Forward transfer admittance | | Y _{fs} | $V_{DS} = -3 \text{ V}, I_D = -10 \text{ mA}$ (Note2) | 25 | _ | _ | mS | |
| Drain-Source on-resistance | | R _{DS} (ON) | $I_D = -10 \text{ mA}, V_{GS} = -4 \text{ V}$ (Note2) | _ | 6 | 8 | Ω | |
| | | | $I_D = -10 \text{ mA}, V_{GS} = -2.5 \text{ V (Note2)}$ | _ | 8 | 12 | | |
| | | | $I_D = -1 \text{ mA}, V_{GS} = -1.5 \text{ V}$ (Note2) | _ | 18 | 45 | | |
| Input capacitance | | C _{iss} | | _ | 11 | _ | pF | |
| Reverse transfer capacitance | | C _{rss} | $V_{DS} = -3 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$ | _ | 3.7 | _ | pF | |
| Output capacitance | | Coss | | _ | 10 | _ | pF | |
| Switching time | Turn-on time | t _{on} | $V_{DD} = -3 \text{ V}, I_D = -10 \text{ mA},$ | _ | 130 | _ | ns | |
| | Turn-off time | t _{off} | $V_{GS} = 0 \sim -2.5 \text{ V}$ | | 190 | _ | | |

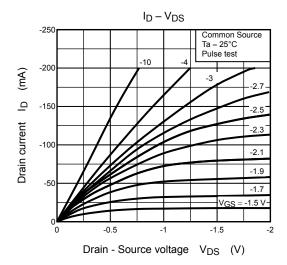
Note2: Pulse test

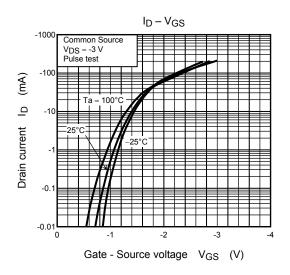
Switching Time Test Circuit

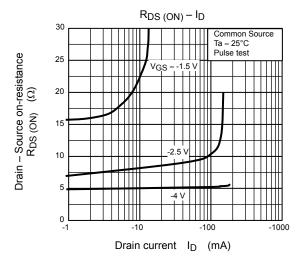


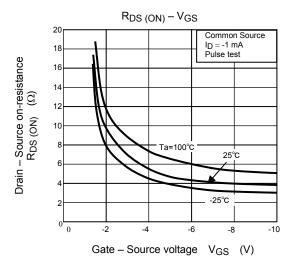
Precaution

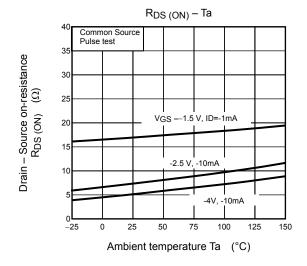
 V_{th} can be expressed as the voltage between the gate and source when the low operating current value is $I_D = -0.1$ mA for this product. For normal switching operation, V_{GS} (on) requires a higher voltage than V_{th} and V_{GS} (off) requires a lower voltage than V_{th} . (The relationship can be established as follows: V_{GS} (off) $< V_{th} < V_{GS}$ (on).) Be sure to take this into consideration when using the device.

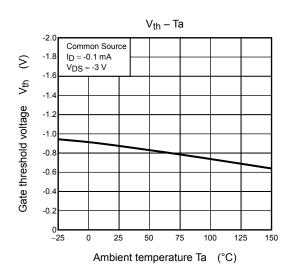


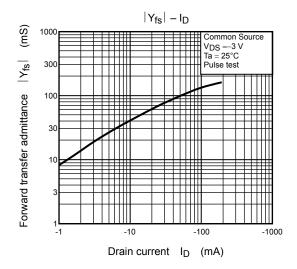


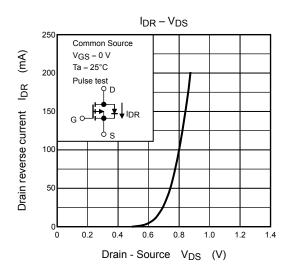


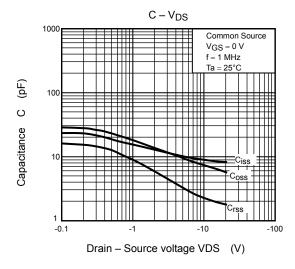


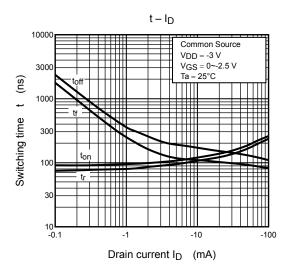


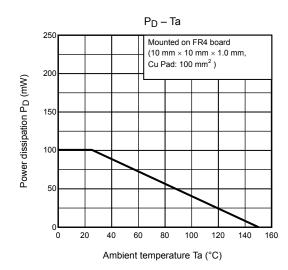












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